

20V P-Channel Enhancement Mode Power MOSFET

Description

WMQ55P02T1 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

- V_{DS} = -20V, I_{D} = -55A $R_{DS(on)}$ < 8.2m Ω @ V_{GS} = -4.5V $R_{DS(on)}$ < 10m Ω @ V_{GS} = -2.5V
- Green Device Available
- Low Gate Charge
- Advanced High Cell Density Trench Technology
- 100% EAS Guaranteed

Applications

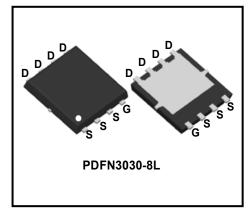
- High Current Load Applications
- Load Switching
- Hard Switched And High Frequency Circuits
- Uninterruptible Power Supply

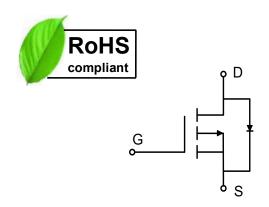
Absolute Maximum Ratings

Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	-20	V	
Gate-Source Voltage		V _{GS}	±10	V	
	T _C =25°C		-55		
Continuous Drain Current ¹	T _C =100°C	l _D	-27	A	
Pulsed Drain Current ²		I _{DM}	-220	Α	
Single Pulse Avalanche Energy³		EAS	20	mJ	
Avalanche Current		I _{AS}	-20	А	
Total Power Dissipation ⁴	T _C =25°C	P _D	39	W	
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	R _{0JA}	38	°C/W
Thermal Resistance from Junction-to-Case ¹	Rejc	3.2	°C/W







Electrical Characteristics T_c = 25°C, unless otherwise noted

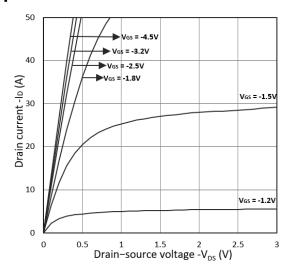
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250µA	-20	-	-	V
Gate-body Leakage current	I _{GSS}	V _{DS} = 0V, V _{GS} = ±10V	-	-	±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20V, V _{GS} = 0V	-	-	-1	μΑ
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.4	-	-1.0	V
Drain-Source on-Resistance ²	R _{DS(on)}	V _{GS} = -4.5V, I _D = -15A	-	6.8	8.2	mΩ
		V _{GS} = -2.5V, I _D = -10A	-	8.5	10	
		V _{GS} = -1.8V, I _D = -8.0A	-	11.2	15	
Dynamic Characteristics	1			l	l	
Input Capacitance	Ciss		-	4550	-	pF
Output Capacitance	Coss	V _{DS} = -10V, V _{GS} =0V, f =1MHz	-	542	-	
Reverse Transfer Capacitance	Crss		-	505	-	
Switching Characteristics					•	
Total Gate Charge	Qg		-	43	-	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = -4.5V, V_{DS} = -10V,$ $I_{D} = -20A$	-	7	-	
Gate-Drain Charge	Q _{gd}		-	9.2	_	
Turn-on Delay Time	t _{d(on)}		-	13.5	-	
Rise Time	tr	$V_{GS} = -4.5V, V_{DD} = -10V,$	-	18.8	-	nS
Turn-off Delay Time	t _{d(off)}	$R_G = 3\Omega$, $I_D = -12A$, $R_L = 1\Omega$,	-	92	-	. 113
Fall Time	t _f		-	161	-	
Drain-Source Body Diode Characte	eristics					
Diode Forward Voltage ²	V _{SD}	I _S = -1A, V _{GS} = 0V	-	-	-1.2	V
Continuous Source Current ^{1,5}	Is	V _G =V _D = 0V , Force Current	-	-	-55	Α
Body Diode Reverse Recovery Time	t _{rr}	1 404 11/14 4004/	-	24	-	nS
Body Diode Reverse Recovery Charge	Q _{rr}	l _F = -12A, dl/dt = 100A/μs	-	26	-	nC

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\,\leqslant\,\,300\text{us}$, duty cycle $\,\leqslant\!2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} = -20V, V_{GS} = -10V, L=0.1mH, I_{AS} = -20A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics



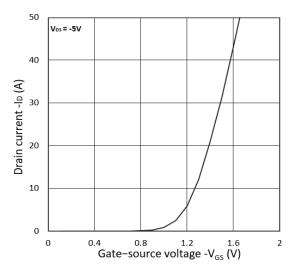


Figure 1. Output Characteristics

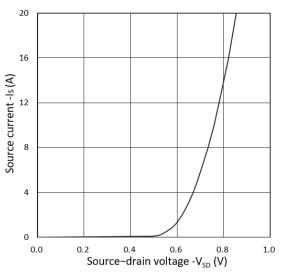


Figure 2. Transfer Characteristics

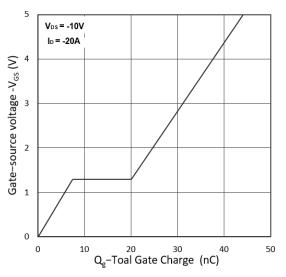


Figure 3. Forward Characteristics of Reverse

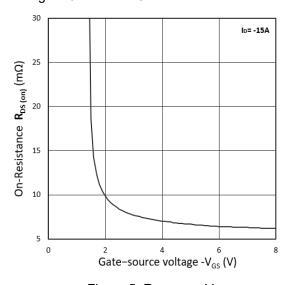


Figure 4. Gate Charge Characteristics

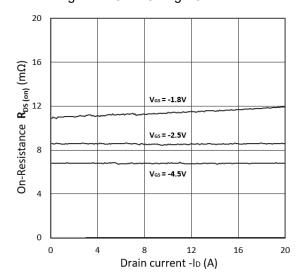
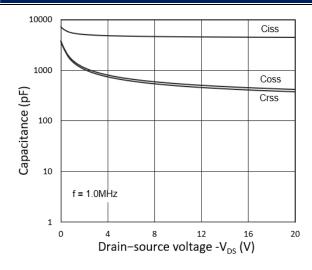


Figure 5. $R_{DS(on)}$ vs. V_{GS}

Figure 6. R_{DS(on)} vs. I_D





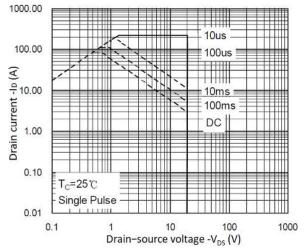


Figure 7. Capacitance Characteristics

Figure8. Safe Operating Area

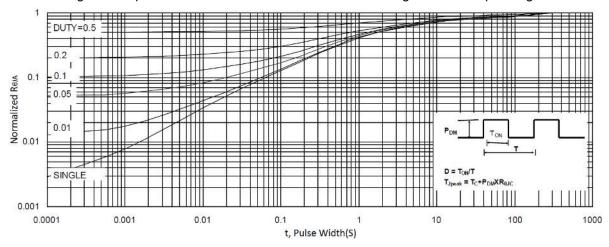
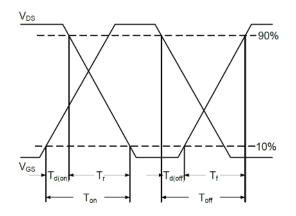


Figure 9. Normalized Maximum Transient Thermal Impedance



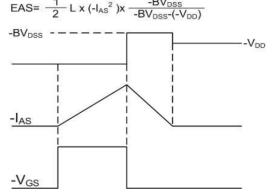


Figure 10. Switching Time Waveform

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Figure 11. Unclamped Inductive Switching

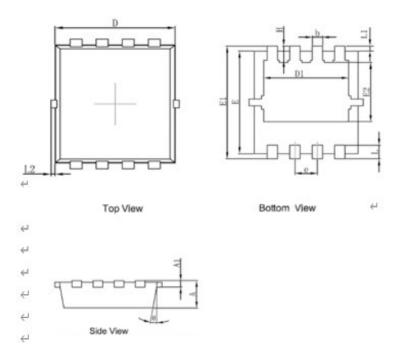
Waveform

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Mechanical Dimensions for PDFN3030-8L



COMMON DIMENSIONS

SYMBOL	MM			
STIVIBUL	MIN	MAX		
А	0.65	0.90		
A1	0.10	0.25		
D	2.90	3.25		
D1	2.25	2.69		
E	2.90	3.20		
E1	3.00	3.60		
E2	1.35	2.20		
b	0.20	0.40		
е	0.65BSC			
L	0.15	0.50		
L1	0.13BSC			
L2	0.00	0.20		
Н	0.15	0.65		
θ	0°	14°		



Ordering Information

Part	Package	Marking	Packing method
WMQ55P02T1	PDFN3030-8L	Q55P02	Tape and Reel

Marking Information



Q55P02= Device code
WWXXXXX= Date code

Contact Information

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